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## \*BIBDATASHEET\*

CONFIRMATION NO. 7172

Bib Data Sheet

<b>SERIAL NUMBER</b> 10/716,606	<b>FILING OR 371(c) DATE</b> 11/20/2003 <b>RULE</b>	<b>CLASS</b> 438	<b>GROUP ART UNIT</b> 2813	<b>ATTORNEY DOCKET NO.</b> 01-100-DIV	
<b>APPLICANTS</b> Hiroaki Himi, Nagoya-city, JAPAN; Noriyuki Iwamori, Okazaki-city, JAPAN; <b>** CONTINUING DATA *****</b> <i>yes TSP</i> This application is a DIV of 09/713,018 11/16/2000 PAT 6,676,748 <b>** FOREIGN APPLICATIONS *****</b> <i>yes CRP</i> JAPAN 11-326934 11/17/1999 JAPAN 2000-333286 10/31/2000 <b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED</b> <b>** 03/01/2004</b>					
Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after met Verified and <i>Allowance</i> Acknowledged <i>TSP</i> Examiner's Signature Initials		<b>STATE OR COUNTRY</b> JAPAN	<b>SHEETS DRAWING</b> 11	<b>TOTAL CLAIMS</b> 20	<b>INDEPENDENT CLAIMS</b> 6
<b>ADDRESS</b> 23400					
<b>TITLE</b> Method for manufacturing semiconductor substrate					
<b>FILING FEE RECEIVED</b> 1128	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit		